

-60V P-Channel Enhancement Mode MOSFET

Description

The AP13P06Y uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

V_{DS} = -60V I_D =-13.5A

 $R_{DS(ON)} < 90m\Omega @ V_{GS}=10V (Type: 80m\Omega)$

Application

Brushless motor

Load switch

Uninterruptible power supply

G D S

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP13P06Y	TO-251L-3L	AP13P06Y XXXX YYYY	4000
AP13P06Y	TO-251S-3L	AP13P06Y XXXX YYYY	4000

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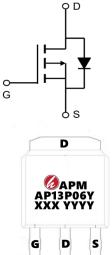
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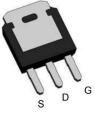
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Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	-60	V
VGS	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ -10V ¹	-13.5	А
I₀@Tc=100°C	Continuous Drain Current, V _{GS} @ -10V ¹	-8.3	A
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ -10V ¹	-3.3	A
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ -10V ¹	-2.7	A
Ідм	Pulsed Drain Current ²	-26	A
EAS	Single Pulse Avalanche Energy ³	29.8	mJ
las	Avalanche Current	-24.4	А
P _D @T _C =25°C	Total Power Dissipation ⁴	31.3	W
P _D @T _A =25°C	Total Power Dissipation ⁴	2	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Reja	Thermal Resistance Junction-Ambient ¹	62	°C/W
Rejc	Thermal Resistance Junction-Case ¹	4.0	°C/W







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P-Channel Electrical Characteristics (TJ =25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-60			V	
∆BVDSS/∆TJ	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =-1mA		-0.03		V/°C	
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-3A		80	90	mΩ	
		V _{GS} =-4.5V , I _D =-2A		100	115	- 11152	
VGS(th)	Gate Threshold Voltage	V_{GS} = V_{DS} , I_{D} =-250 uA	-1.2	1.75	-2.5	V	
	Drain Source Lookage Current	$V_{\text{DS}}\text{=-}48\text{V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}25^{\circ}\text{C}$			1		
IDSS	Drain-Source Leakage Current	$V_{\text{DS}}\text{=-48V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}55^{\circ}\text{C}$			5	uA	
IGSS	Gate-Source Leakage Current	V_{GS} =±20V , V_{DS} =0V			±100	nA	
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-3A		8.5		S	
Qg	Total Gate Charge (-4.5V)			12.1			
Qgs	Gate-Source Charge	V_{DS} =-48V , V_{GS} =-4.5V , I_{D} =-3A		2.2		nC	
Qgd	Gate-Drain Charge			6.3			
Td(on)	Turn-On Delay Time			9.2			
Tr	Rise Time	V _{DD} =-15V , V _{GS} =-10V , R _G =3.3□,		20.1		20	
Td(off)	Turn-Off Delay Time	RG−3.3⊔, I _D =-1A		46.7		ns	
Tf	Fall Time			9.4			
Ciss	Input Capacitance			1137			
Coss	Output Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		76		pF	
Crss	Reverse Transfer Capacitance			50			
IS	Continuous Source Current ^{1,5}	$V_G=V_D=0V$, Force Current			-13	А	
VSD	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25℃			-1.2	V	

Note :

1、The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.

2. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3、The EAS data shows Max. rating . The test condition is V DD =-25V,V GS =-10V,L=0.1mH,IAS =-24A

 $4\,{\scriptstyle \sim}\,$ The power dissipation is limited by $150\,{\rm ^{\circ}C}$ junction temperature

5. The data is theoretically the same as I D and I DM, in real applications, should be limited by total power dissipation.

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P-Channel Typical Characteristics

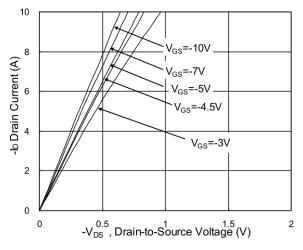


Fig.1 Typical Output Characteristics

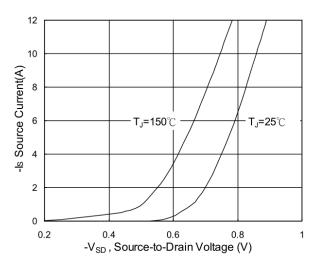


Fig.3 Forward Characteristics of Reverse

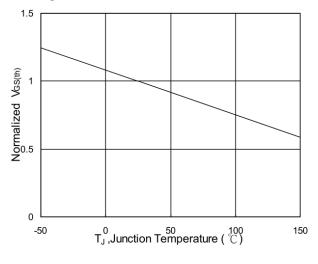


Fig.5 Normalized $V_{\text{GS(th)}}$ v.s T_{J}

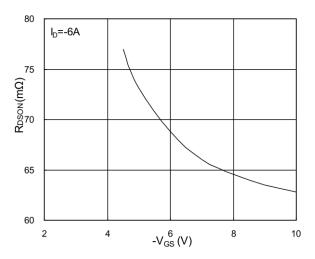


Fig.2 On-Resistance v.s Gate-Source

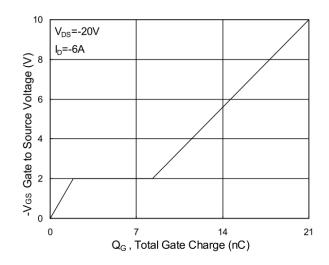


Fig.4 Gate-Charge Characteristics

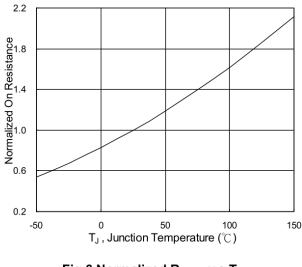


Fig.6 Normalized R_{DSON} v.s T_{J}



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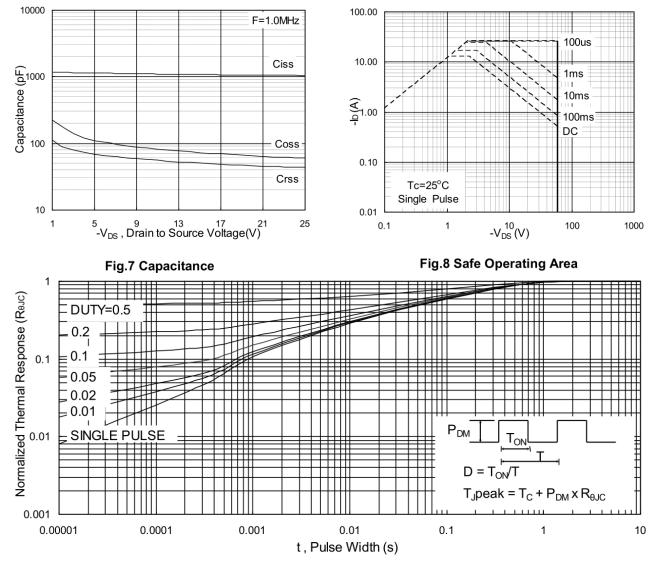
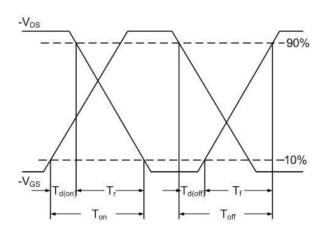


Fig.9 Normalized Maximum Transient Thermal Impedance





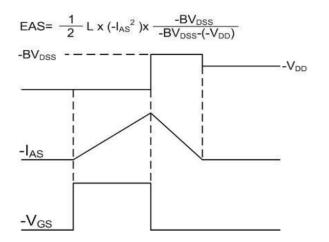


Fig.11 Unclamped Inductive Switching Waveform



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Package Mechanical Data-TO-251L-3L

TO-251

	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max
A	2.20		2.40	0.086		0.095
A2	0.90		1.20	0.035		0.047
в	0.55		0.65	0.022		0.026
B2	5.10		5.40	0.200		0.213
B3	0.76		0.85	0.030		0.033
С	0.45		0.62	0.018		0.024
C2	0.48		0.62	0.019		0.024
D	6.00	1	6.20	0.236		0.244
E	6.40		6.70	0.252		0.264
G		2.30			0.091	
н	16.0		17.0	0.630		0.669
L	8.90		9.40	0.350		0.370
L1	1.80		1.90	0.071		0.075
L2	1.37		1.50	0.054		0.059
V1		4°	1		4°	

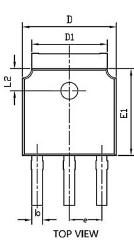
Package Information -TO-251

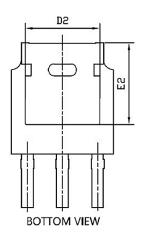
OUTLINE	TUBE	INNER BOX	PER CARTON
	(PCS)	(PCS)	(PCS)
TUBE	80	4,000	32,000

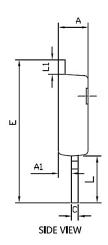


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Package Mechanical Data-TO-251S-3L







	Common			
Symbol	mm			
	Mim	Nom	Max	
А	2.2	2.3	2.4	
A1	0.9	1.0	1.1	
b	0.66	0.76	0.86	
С	0.46	0.52	0.58	
D	6.50	6.6	6.7	
D1	5.15	5.3	5.45	
D2	4.6	4.8	4.95	
E	10.4		11.5	
E1	6.0	6.1	6.2	
E2	5.400REF			
е	2.286BSC			
L	3.5	4.0	4.3	
L1	0.9		1.27	
L2	1.4		1.9	

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Edition	Date	Change
Rve1.0	2021/4/13	Initial release

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